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480 x 480	HDMI Interface	TFT Module
	Specification	
	Date: 15/10/2023	
	Revision	
07/04/2023	First issue	
13/10/2023	Updated	
	07/04/2023	Specification   Date: 15/10/2023     Revision     07/04/2023   First issue

Display F			
Display Size	4.00"		
Resolution	480 x 480		
Orientation	Square		
Appearance	RGB		1
Logic Voltage	12V		oHS ompliant
Interface	HDMI		$\mathbf{O}\mathbf{H}\mathbf{O}$
Brightness	1000 cd/m <sup>2</sup>		mnliant
Touchscreen	SPLA	500	mphant
Module Size	77.00 x 80.00 x 17.75 mm		
Operating Temperature	-10°C ~ +60°C		
Pinout		Box Quantity	Weight / Display
Pitch			

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Display Accessories				
Part Number	Description			
MDIB-CC1	The MDIB-CC1 is a interconnect board for standard pitch pinouts to fine pitch wires. Ideal for prototyping of TFT and COG LCDs.			

Optional Variants				
Appearances	Voltage			

### **Basic Specifications**

### \* Description

This is a plug and play device, this is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This module is composed of a Transmissive

type TFT-LCD Panel, driver circuit,back-light unit, HDMI adapter board. The resolution of a 4.0 " TFT-LCD contains 480x480 pixels, and can display up to 16.7M colors.

#### \* Operating Instructions

This product supports the following operating systems: Windows 7/8/10, Android, Linux, Raspberry Pi. 1. Connect the DC-044 DC power.

- 2. Connect the HDMI cable to Windows 7/8/10 or Android or Linux or Raspberry Pi.
- 3. Connect the micro USB for touch panel, if this module supports it.

#### 1. TFT Features

General Information	Specification	Unit	Note
Items	Main Panel	Offic	Note
Display area(AA)	71.86(H)*70.18V) (4.0 inch)	mm	
Driver element	TFT active matrix	_	
Display colors	16.7M	colors	
Number of pixels	480(RGB)*480	dots	
Pixel arrangement	RGB vertical stripe	-	
Pixel pitch	0.1497(H)*0.1462(V)	mm	
Viewing angle	MANUFARCTURE .	o'clock	LY
Display mode	Transmissive /Normally Black	-	
Operating temperature	-10~+60	$^{\circ}$	
Storage temperature	-20~+70	$^{\circ}$	

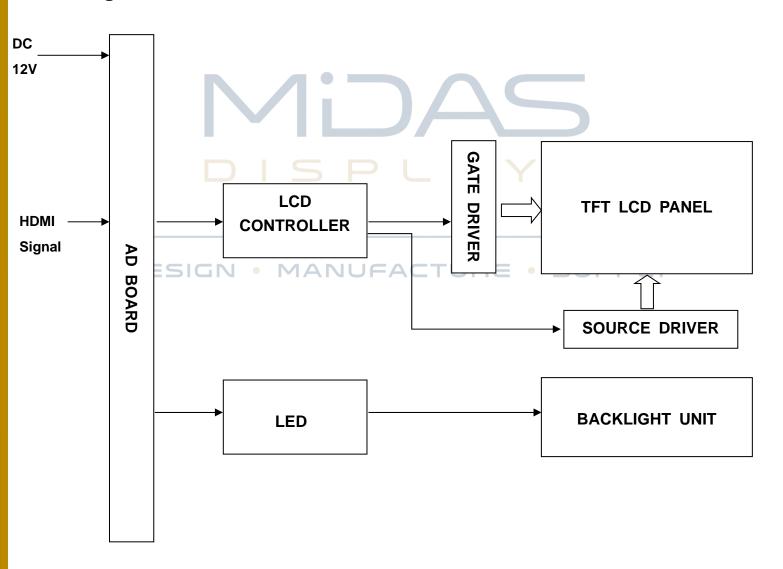
#### 2. Module Features

General Information Items	Specification	Unit	Note
Display Interface	HDMI(Type A)	-	
Touch Interface	-	-	
Touch Type	-	-	
Touch Mode	-	-	
Power supply	DC-12V(DC-044)	-	

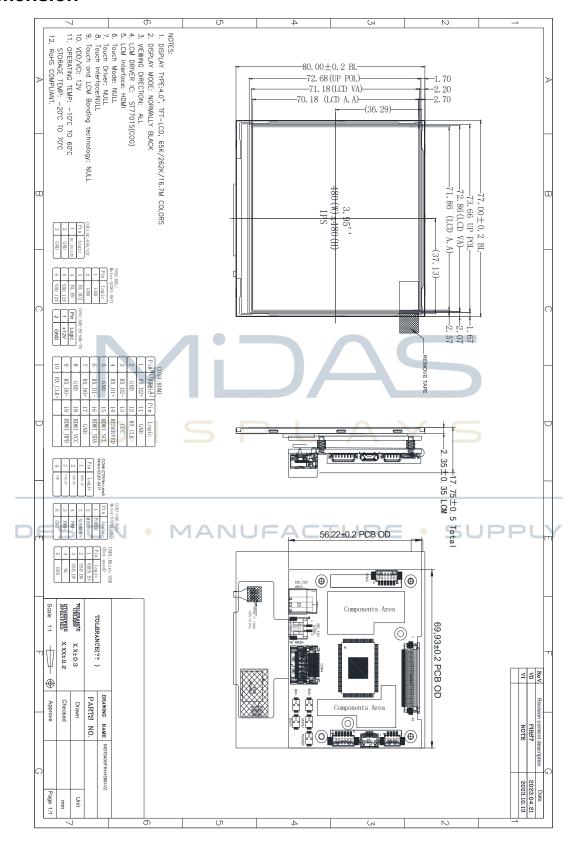
#### 3. Mechanical Information

	Item	Min.	Тур.	Max.	Unit	Note
	Horizontal(H)	-	77	-	mm	
Module	Vertical(V)	-	80	-	mm	
size	Depth(D)	-	17.75	-	mm	
Weight		-	TBD	-	g	

# **Block Diagram**



### **Outline dimension**



# **Pin Assignment**

### 1. Power Input

# CON1(DC-044 Socket)

NO.	SYMBOL	DISCRIPTION	I/O
1	DC_IN	Power supply (DC 12V).	Р
2	GND	Ground	Р
3	GND	Ground	Р

### Extension CON3(JST:S2B-PH-SM4-TB)

NO.	SYMBOL	DISCRIPTION	I/O
1	+12V	Power supply (DC 12V).	Р
2	GND	Ground	Р

# 2. Touch Input (not used) | S P L A Y S

# USB1(Micro USB)

NO.	SYMBOL	DISCRIPTION	I/O
1	VBUS_5V	Supply voltage(5V).	Р
2	USB_DN	USB- signal.	I/O
3	USB_DP	USB+ signal.	I/O
4	NC	No connection.	
5	GND	Ground.	Р

# Extension CON6(Molex:53261-0471)

NO.	SYMBOL	DISCRIPTION	I/O
1	VBUS_5V	Supply voltage(5V).	Р
2	USB_DN	USB- signal.	I/O
3	USB_DP	USB+ signal.	I/O
4	GND	Ground.	Р

# 3. HDMI Input

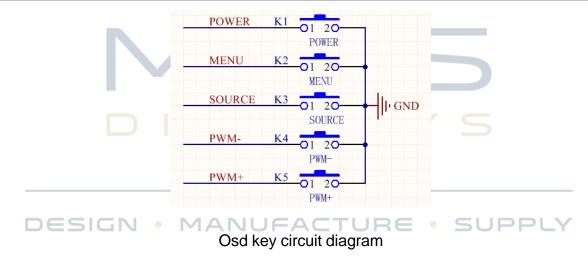
The type of HDMI connector is a type A.

NO.	SYMBOL	DISCRIPTION	I/O
1	RX_D2+	HDMI Receiver channel 2 positive analog input.	I/O
2	GND	Ground.	Р
3	RX_D2-	HDMI Receiver channel 2 negative analog input.	1/0
4	RX_D1+	HDMI Receiver channel 1 positive analog input.	I/O
5	GND	Ground.	Р
6	RX_D1-	HDMI Receiver channel 1 negative analog inpsut.	1/0
7	RX_D0+	HDMI Receiver channel 0 positive analog input.	1/0
8	GND	Ground.	Р
9	RX_D0-	HDMI Receiver channel 0 negative analog input.	1/0
10	RX_CLK+	HDMI Receiver clock positive analog input.	I
11	GND	Ground.	Р
12	RX_CLK-	HDMI Receiver clock negative analog input.	I
13	CEC/DET_HD MI	No connection.  No MANUEACTURE • SUPPLY	
14	NC	No connection.	
15	HDMI_SCL	HDMI Receiver DDC data channel.	1
16	HDMI_SDA	HDMI Receiver DDC clock channel.	1/0
17	GND	Ground.	Р
18	HDMI_5V	HDMI Supply voltage (5.0V).	Р
19	HPD	HDMI Receiver hot plug detect output	0

# 4. OSD Key Output

CON7(Molex: 53261-0671)

NO.	SYMBOL	DISCRIPTION	I/O
1	POWER	Power supply control.	1
2	MENUL	Switch to the menu control.	
2 MENU		Note:It will be dummy, if the resolution is lower than 640x480.	I
2 0011005		Switch the input signal control, there is only HDMI signal,	
3	SOURCE	With return function in the menu interface.	I I
4	PWM-	Reduce brightness of backlight.	I
_	D)A/A4.	Increase brightness of backlight.	
5	PWM+	Note: The brightness is configured for maximum after power on.	I
6	GND	Ground	Р



#### 5. Extension Backlight Output

CON2(Molex: 53261-0671)

NO.	SYMBOL	DISCRIPTION	I/O
1	GND	Ground.	Р
2	GND	Ground.	Р
3	BL_ADJ	PWM signal output.	0
4	BL_EN	Enable signal.	0
5	12V	Power supply.	Р
6	12V	Power supply.	Р

# **LCM Optical Characteristics**

#### 1. Optical specification

Item		Symbol	Condition	Min.	Тур.	Max.	Unit.	Note
Contrast Ratio		CR		640	800			(1)(2)
Response time	Rising	$T_{R+}T_{F}$			25	35	msec	
	Falling			55	60		%	(1)(3)
Color Gar	mut	S(%)		640	800			
LCM Lumin	ance	LV		800	1000		cd/m2	
		Wx	Θ=0		0.309			(1)(4)
	White	W <sub>Y</sub>	Normal viewing	-0.02	0.350	+0.02		CF
	Red	R <sub>X</sub>	angle		0.611			glass
Color Filter		Ry			0.363			
Chromacicity	Green	G <sub>X</sub>		-0.04	0.317	+0.04		
		G <sub>Y</sub>		-0.04	0.570	+0.04		
		B <sub>X</sub>	5 P L	A	0.150			
	Blue	B <sub>Y</sub>			0.100			
	Llan	ΘL		70	80	<u></u>		(1)(4)
Visuria a supple	Hor.	ΘR	ANWEACT	70	80	PPL	Y	
Viewing angle	Var	ΘU	CR>10	70	80			
	Ver.	ΘD		70	80			
Option View D	irection		12 o'clock					

<sup>\*</sup>The data comes from the LCD specification.

#### **Measuring Condition**

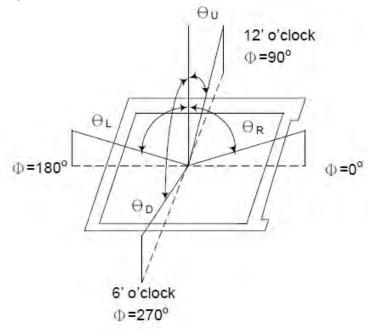
Measuring surrounding : dark room Ambient temperature : 25±2°C

15min. warm-up time.

#### **Measuring Equipment**

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

#### Note (1): Definition of Viewing Angle:

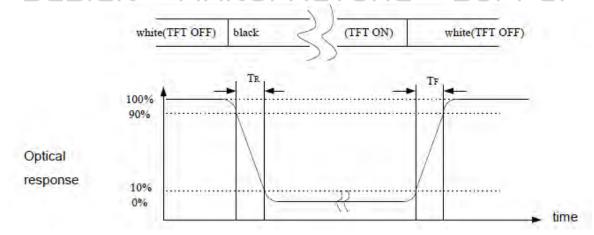


Note (2): Definition of Contrast Ratio(CR) :measured at the center point of panel

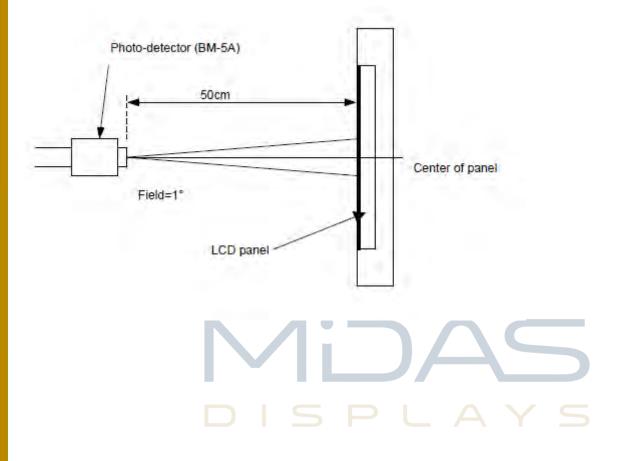
CR = Luminance with all pixels white

Luminance with all pixels black





Note (4): Definition of optical measurement setup



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#### **Electrical Characteristics**

#### 1. Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	DC_IN	-0.5	16	V	Note1
Operating temperature	T <sub>OP</sub>	-10	+60	°C	
Storage temperature	T <sub>ST</sub>	-20	+70	°C	

NOTE1: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

#### 2. DC Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	DC_IN	9	12	16	V	
Normal mode Current consumption	IDC_IN		200		mA	DC_IN=12V

### **LCM Module Out-Going Quality Level**

#### 1. VISUAL & FUNCTION INSPECTION STANDARD

#### 1.1 Inspection conditions

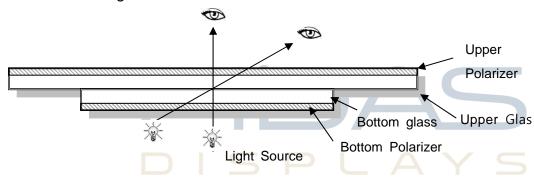
Inspection performed under the following conditions is recommended. Temperature : 25±5  $^{\circ}\mathrm{C}$ 

Humidity: 65%±10%RH

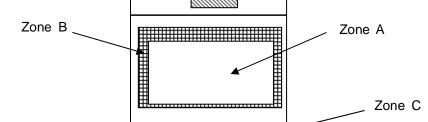
Viewing Angle: Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm







Zone A: Effective Viewing Area(Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A+Zone B) which can not be seen after assembly by customer.)

Zone D: IC Bonding Area

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or ap pearance after assembly by customer

# 1.3 Sampling Plan

According to GB/T 2828.1-2003 ; , normal inspection, Class  $\,{\rm II}\,$  AQL:

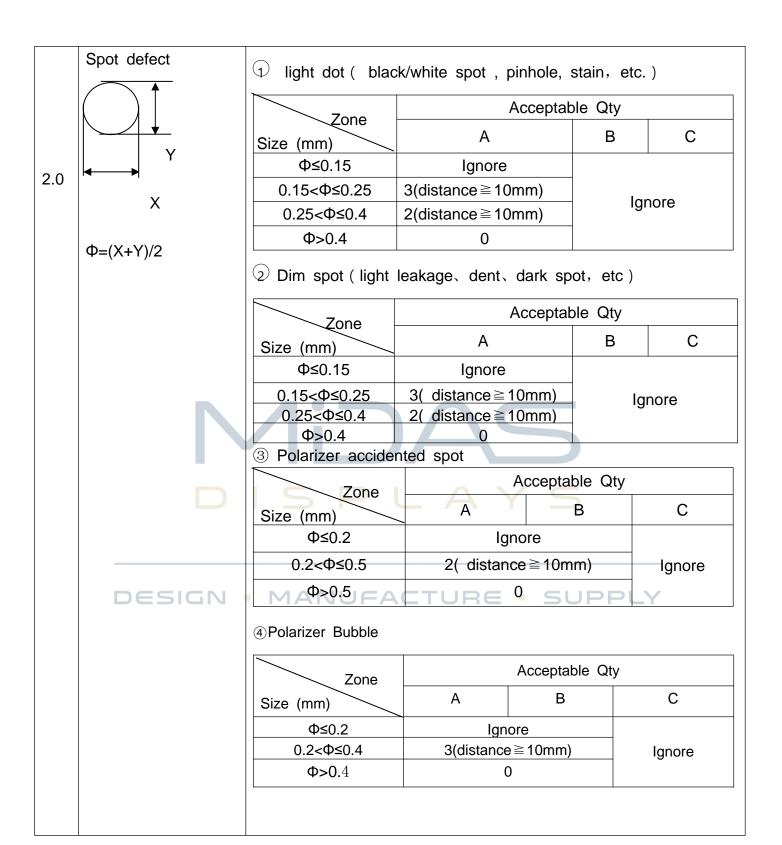
Major defect	Minor defect			
0.65	1.5			

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspec	d Criteria	Classification of defect
			s
1	Functional defects	<ol> <li>No display, Open or miss line</li> <li>Display abnormally, Short</li> <li>Backlight no lighting, abnormal lighting.</li> <li>TP no function</li> </ol>	Major
2	Missing	Missing component	,
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	
5	Spot Line defect	Light dot, Dim spot,Polarizer Bubble; Polarizer accidented spot.	Minor
6	Soldering appearan	Good soldering, Peeling off is not allowed.	UPPLY
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

# 1.4 Criteria (Visual)

Number	Items	Criteria(mm)				
1.0 LCD Crack/Broken NOTE: X: Length Y: Width Z: Height	(1) The edge of LCD broken					
L: Length of IT		X Y Z				
O, T: Height of LCD		≤3.0mm <inner border="" he="" line="" of="" seal="" t="" td="" ≤t<=""></inner>				
	(2)LCD corner broken	X Y Z ≤3.0mm ≤L ≤T				
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	(3) LCD crack	Crack Not allowed				



3.0	LCD Pixel defect	Pixel bad po	ints	
		Item	Zone A	Acceptable Qt
			Random	N≤2
		Bright dot	2 dots adjacent	N≤0
			3 dots adjacent	N≤0
		Dark dot	2 dots adjacent	N≤0
		Dank dot	3 dots adjacent	N≤0
		Distance	<ol> <li>Minimum Distance Between Bright dots.</li> <li>Minimum Distance Between dark dots</li> <li>Minimum Distance Between dark and bright dot.</li> </ol>	5mm
		Total bright	N≤4	
		Note:	and dark dot	1127
		A) Bright dot	: Dots appear bright and unchange	d in size in which
			Dots appear dark and unchanged ir isplaying under pure red, green, blu	
	DESIGN	C) 2 dot adja	JEACTURE • SUF acent = 1 pair = 2 dots	PPLY
		2 dot adj	acent 2 dot adjace	nt
		2 dot adjace	nt (vertical) 2 dot adjace	nt (slant)

	Line defect (LCD						
	/Polarizer backlight bl	NA/: alth (an an)	Length(m	Acceptable Qty			
	ack/white line, scratc	Width(mm)	m)	А	В	С	
	h, stain)	Ф≤0.05	Ignore	Ignor	е		
4.0		0.05 <w≤0.06< td=""><td>L≤4.0</td><td>N≤3</td><td></td><td>Ignore</td></w≤0.06<>	L≤4.0	N≤3		Ignore	
	W: width, L: length	0.06 <w≤0.08< td=""><td>L≤3.0</td><td>N≤2</td><td></td><td></td></w≤0.08<>	L≤3.0	N≤2			
	N : Count	W>0.08	[	Define as spo	ot defect		
	Electronic Compone Not allow missing parts, solderless connection, cold solder joint, match, The positive and negative polarity opposite						
5.0	nts SMT.	materi, The positive a	and negative	роганту орро	Site		
6.0	Display color& Brigh tness.	<ol> <li>Color: Measuring the color coordinates, The measurement standard according to the datasheet or samples.</li> <li>Brightness: Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.</li> </ol>					
7.0	LCD Mura/Waving/	Not visible through 5° e if necessary.	% ND filter in	n 50% gray	or judge	by limit samp	
Hot spot							

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	CTP	CTD Cover		A	cceptable Qty	/
	Related	CTP Cover sensor ac	Size Φ(mm)	A	В	С
		cidented	Ф≤0.1	Ign	ore	
8.0			0.1<Φ≤0.2	3 ( distance ≥ 10mm )		Ignore
	spot	0.20<Φ≤0.25	2 ( distance ≥ 10mm )			
			Ф > 0.25	0		

	T					
		Width(mm)	Ignore		eptable C	
	CTP Cover	Ф≤0.05	(mm) Ignore	Α	B	С
		Φ≤0.05 0.05 <w≤0.06< td=""><td>lgriore L≤4.0</td><td></td><td>Ignore N≤3</td><td></td></w≤0.06<>	lgriore L≤4.0		Ignore N≤3	
	scratch	0.05 <w≤0.06 0.06<w≤0.08< td=""><td>L≤4.0 L≤3.0</td><td></td><td>N≤2</td><td></td></w≤0.08<></w≤0.06 	L≤4.0 L≤3.0		N≤2	
		0.08 <w< td=""><td></td><td>ne as spo</td><td></td><td></td></w<>		ne as spo		
		Zone		Acceptal		
	CTP Cover	Size (mm)		C	;	
	Pinhole/ L	Ф≤0.1		Igno	ore	
	ack of ink	0.1<Φ≤0.25		3(distance		
		<u>0.25&lt;Φ≤0.3</u> Φ>0.3	2	2(distance 0	-	
		Ψ>0.3				
	CTP Bondi	Size Φ(mm)		Acceptable		
	ng bubble/	Ф≤0.1	А		В	
	accidented	0.1<Φ≤0.2	<del>\</del>	Ignore		
	spot	0.2<Φ≤0.25	0/4	·	10	
		Ф>0.25	O/4;	0	10mm \	
DESIGN	Assembly deflection	beyond the edge of	<b>R S S S S S S S S S S</b>	5UPI 0.2mm	PLY	
	CTP cover broken	X Y	Z Z <cover t<="" td=""><td>x &gt;</td><td></td><td>Y</td></cover>	x >		Y
	X : length	X≤0.5mm Y≤0.5mm	hickness	Z		
	Y: width	* Circuitry broken i	s not allowe			
	Z : height	d.				

	CTP cover	Х	Y	Z	X
		X≤0.3mm	Y≤0.3mm	Z <cover< td=""><td rowspan="2">z</td></cover<>	z
				thickness	
		* Circuitry broken is not allowe			
	Y: width	d.			
	Z : height				

Criteria ( functional items)

Number 1 2 3 4	Items No display Missing segment Short Backlight no lighting	Criteria (mm)  Not allowed  Not allowed  Not allowed  Not allowed
5	TP no function	Not allowed

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**Reliability Test Result** 

Item	Condition	Inspection after test
High Temperature Operating	60°C,96HR	
Low Temperature Operating	-10°C, 96HR	
High Temperature Storage	70°C, 96HR	
Low Temperature Storage	-20°C, 96HR	Inspection after 2~4hours storage at room temperature,
High Temperature & High	+60°C, 90% RH ,96 hours.	the sample shall be free from
Humidity Operating		defects:
Thermal Shock (Non-operation)	-10°C,30 min ↔ 60°C,30 min,	1.Air bubble in the LCD;
, i	Change time:5min 20CYC.	2.Non-display;
	C=150pF, R=330,5points/panel	3.Missing segments/line;
ESD test	Air:±8KV, 5times; Contact:±6KV, 5 times;	4.Glass crack;
	(Environment: 15°C~35°C, 30%~60%).	5.Current IDD is twice higher
DESIGI	Frequency range:10~55Hz, Stroke:1.5mm	than initial value.
Vibration (Non-operation)	Sweep:10Hz~55Hz~10Hz 2 hours for each direction of	
	X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80cm(MEDIUM BOX)	

#### Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 3~10pcs.
- 3. For Damp Proof Test, Pure water(Resistance >  $10M\Omega$ ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

#### **Cautions and Handling Precautions**

#### 1. Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
- Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
- If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
- Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.

#### 2. Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
- It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
- In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.